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(12)

United States Design Patent

Monroe et al.

(10)

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(45)

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(54) EARPHONE CASE

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(**) Term: 15 Years

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(52) U.S. Cl. USPC D3/294; D14/223

(58) Field of Classification Search
USPC D3/294, 284, 288, 298, 301, 303, 201, D3/215, 269, 273, 274, 276, 282, 295, D3/302; D13/107, 108, 110, 118, 119, D13/123, 184, 199; D14/474, 440, 205, D14/206, 223
CPC A45C 11/24; A45C 13/02; A45C 11/00; A45C 2011/001; A45C 2011/002; A45C 2011/003; H04R 1/1025; H04R 2460/17; H04R 2225/31; H04M 1/0283; H04M 1/026; H04M 1/0262; H04M 1/0266; H05K 5/0004; H05K 5/0013; H05K 5/06
See application file for complete search history.

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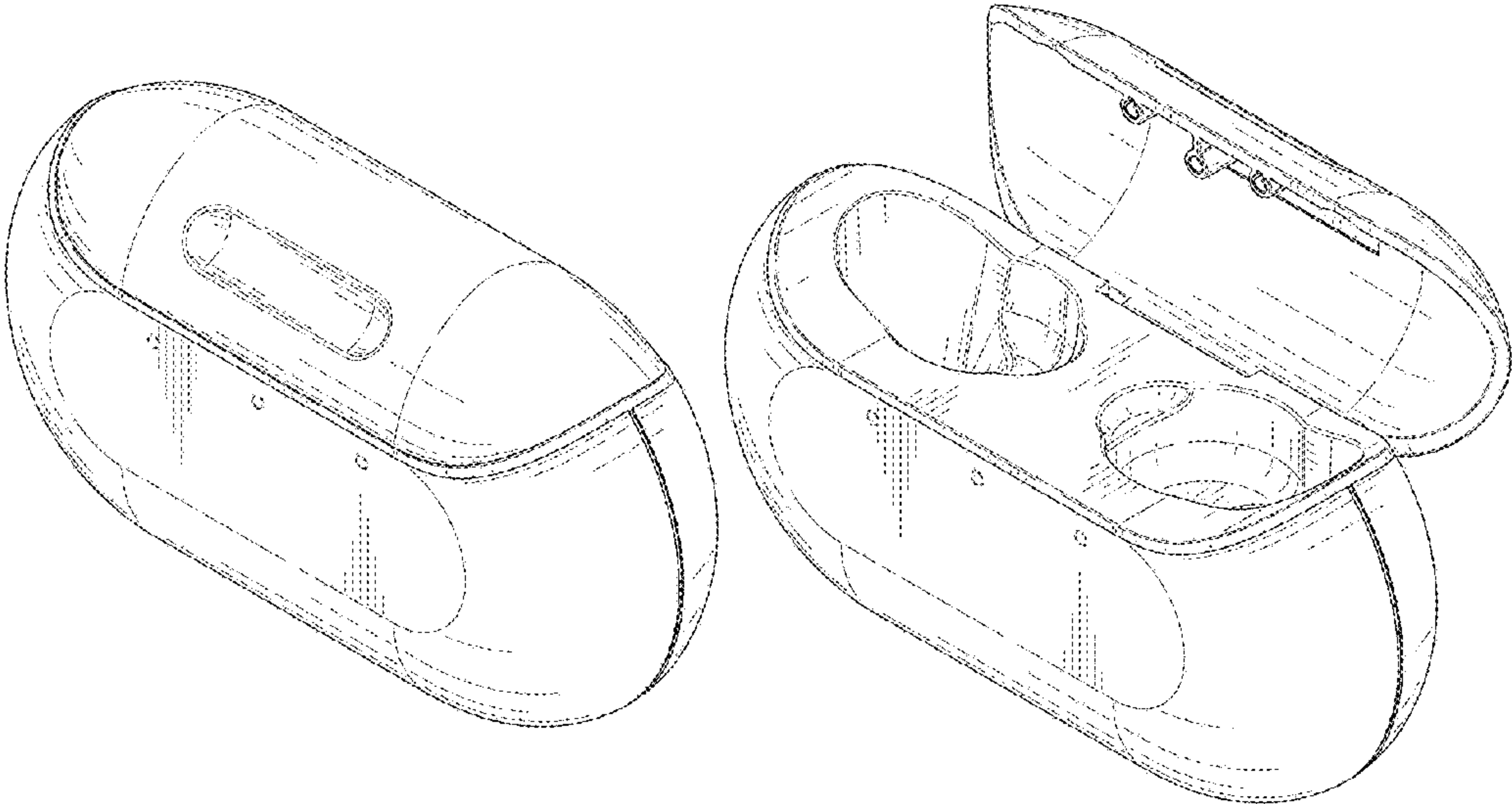
(57) CLAIM

The ornamental design for an earphone case, as shown and described.

DESCRIPTION

FIG. 1 is a front perspective view of an earphone case showing our new design in a closed position; FIG. 2 is a front elevation view thereof; FIG. 3 is a rear elevation view thereof; FIG. 4 is a right side elevation view thereof; FIG. 5 is a left side elevation view thereof; FIG. 6 is a top plan view thereof; FIG. 7 is a bottom plan view thereof; FIG. 8 is a front perspective view of the earphone case showing our new design in an open position; FIG. 9 is a front elevation view thereof; FIG. 10 is a rear elevation view thereof; FIG. 11 is a right side elevation view thereof; FIG. 12 is a left side elevation view thereof; FIG. 13 is a top plan view thereof; and, FIG. 14 is a bottom plan view thereof. The dashed broken lines in the figures illustrate portions of the earphone case that form no part of the claimed design.

1 Claim, 8 Drawing Sheets



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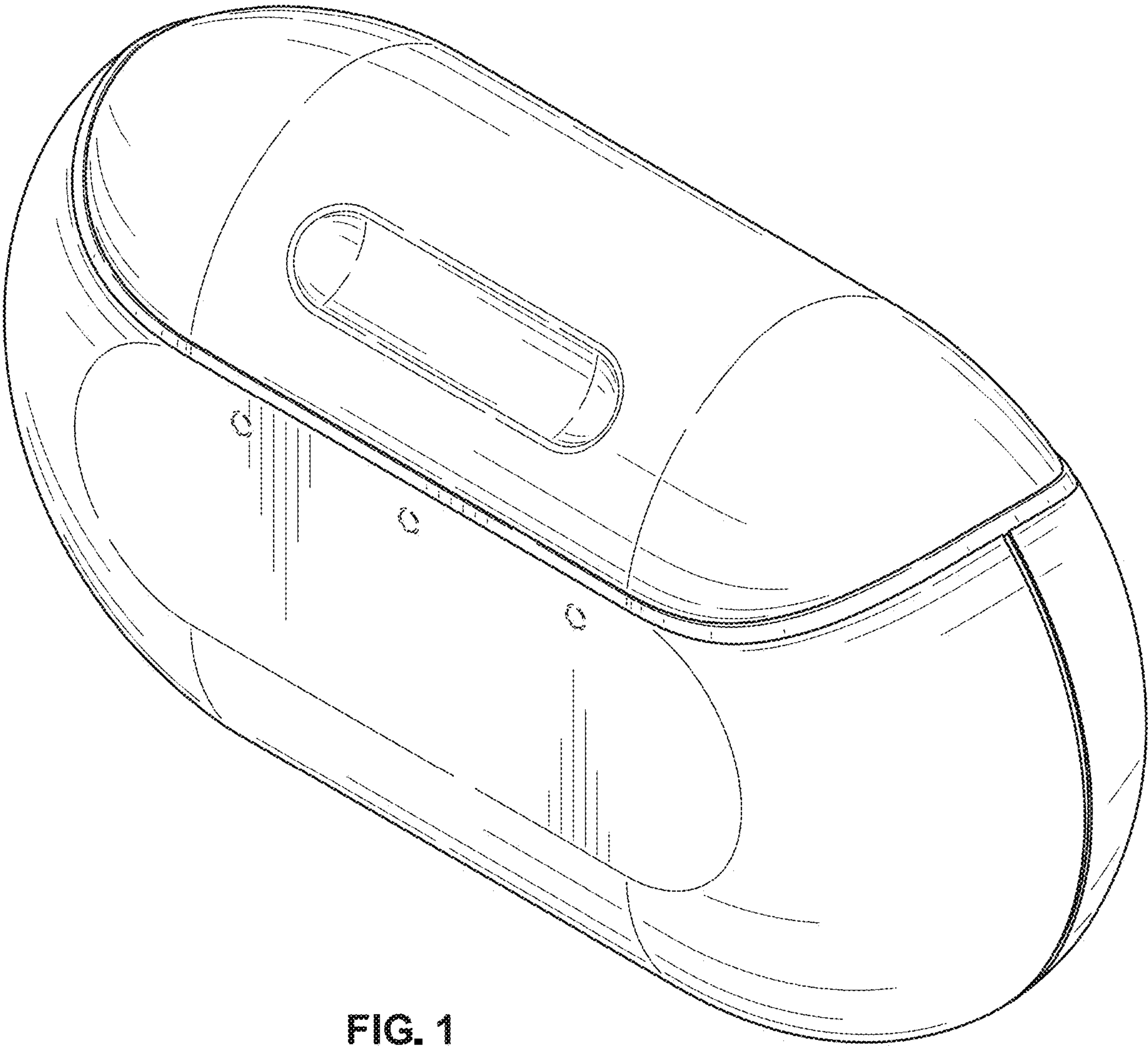


FIG. 1

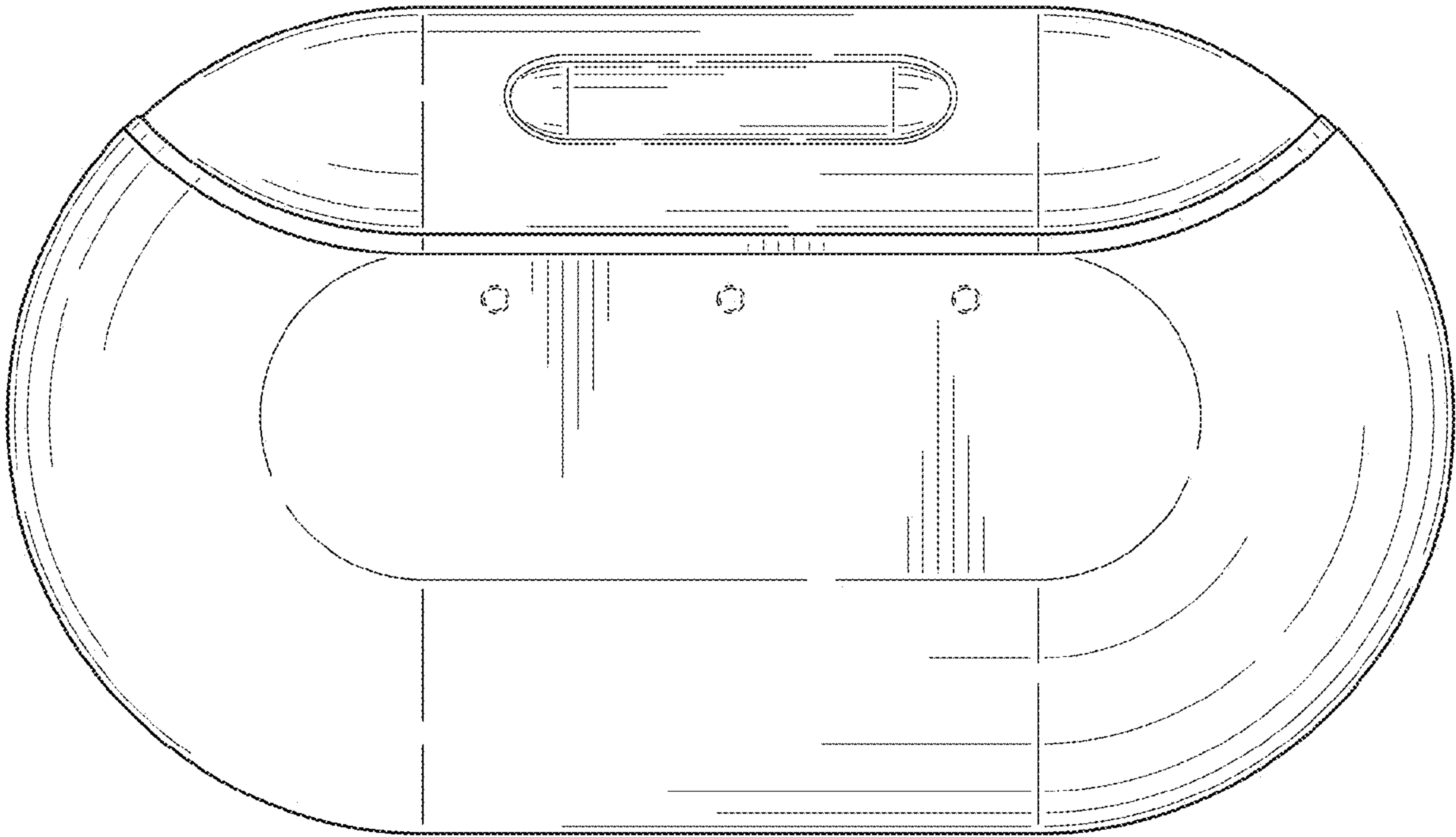


FIG. 2

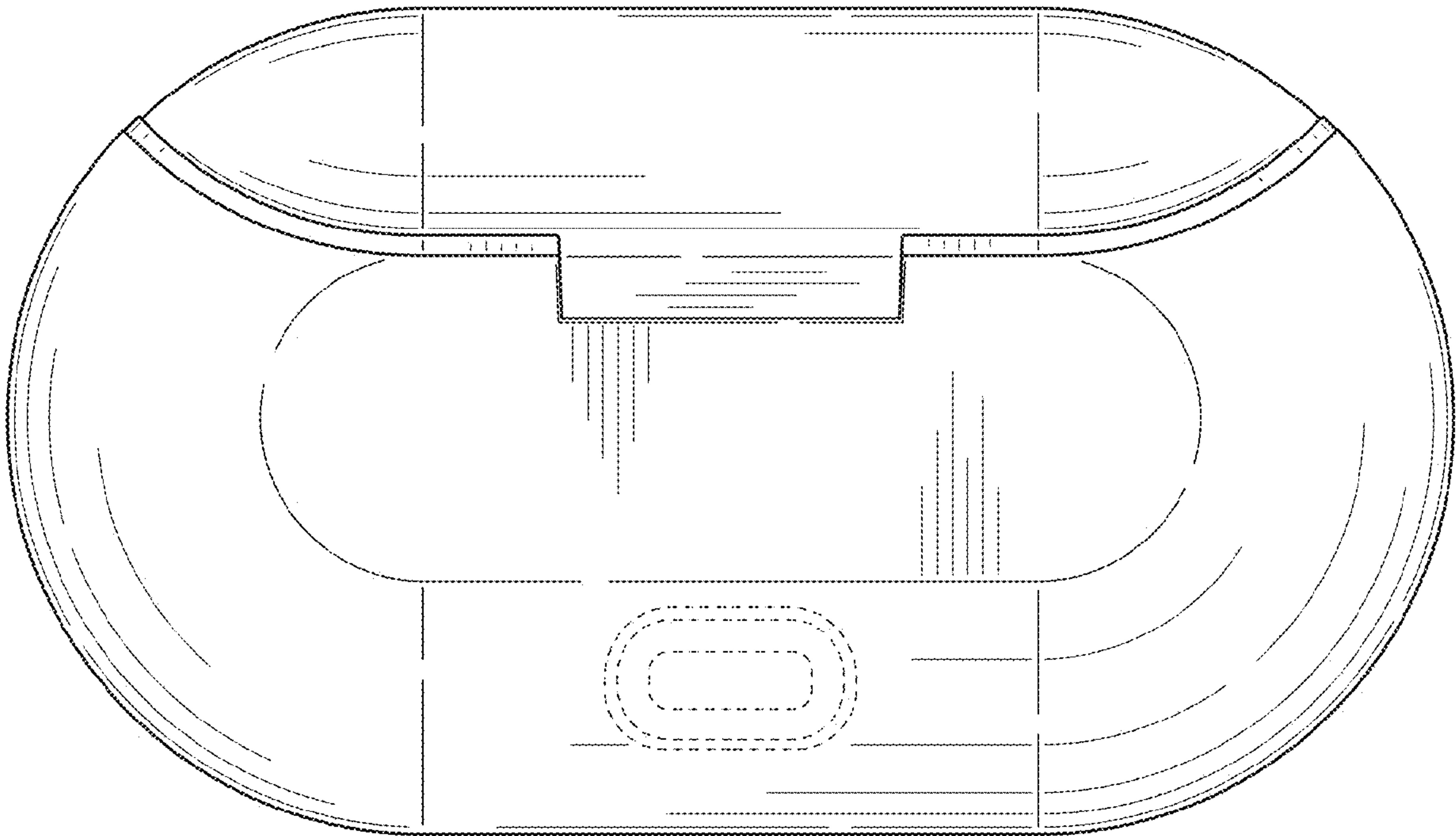


FIG. 3

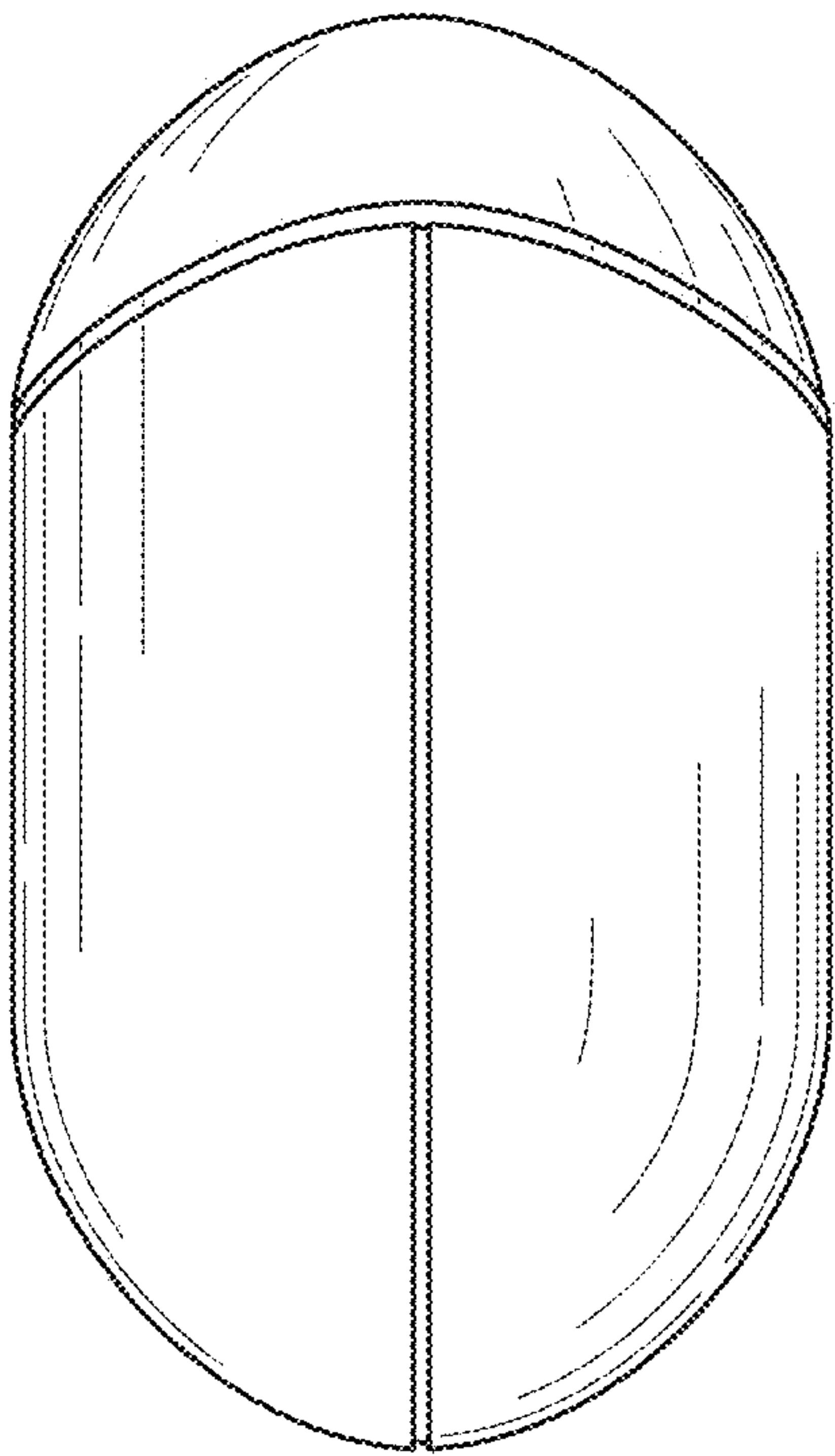


FIG. 4

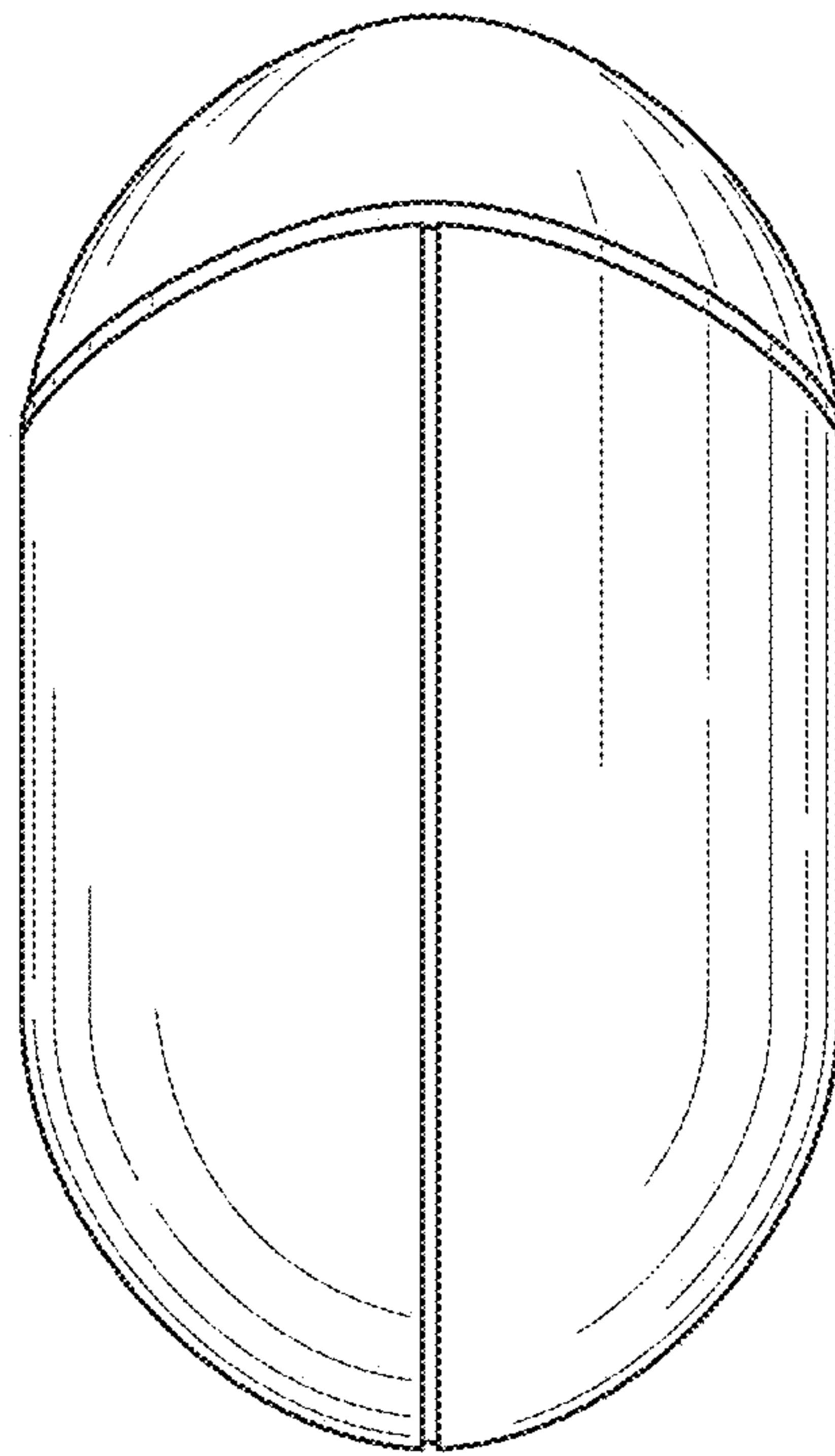


FIG. 5

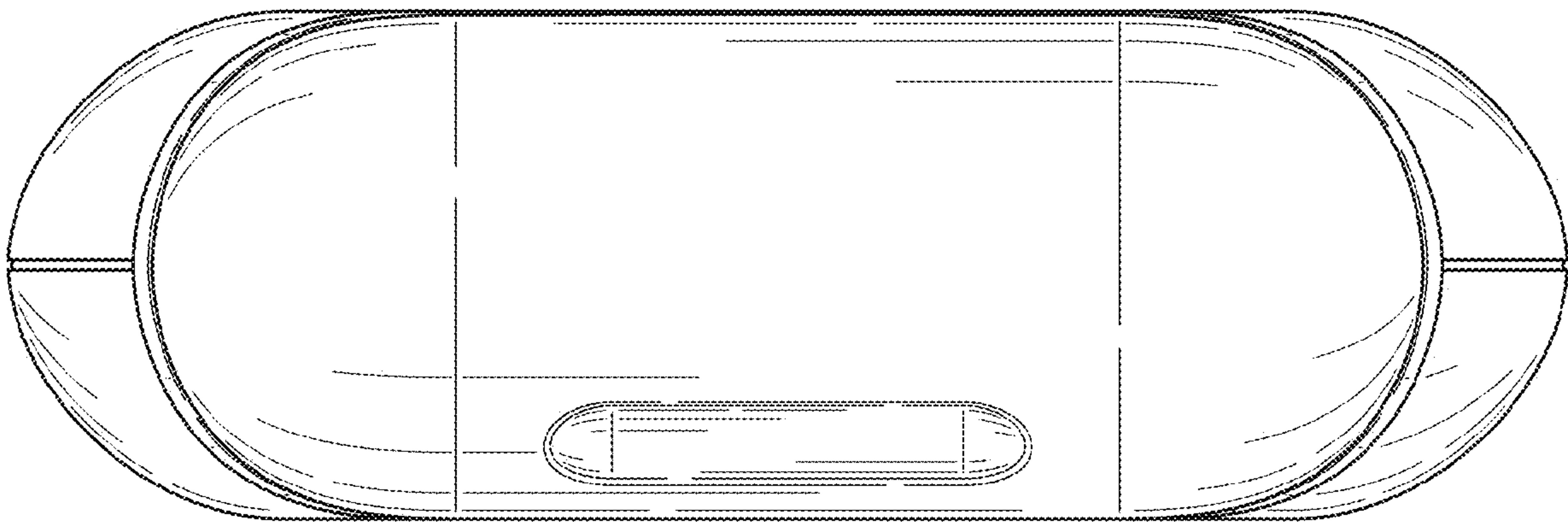


FIG. 6

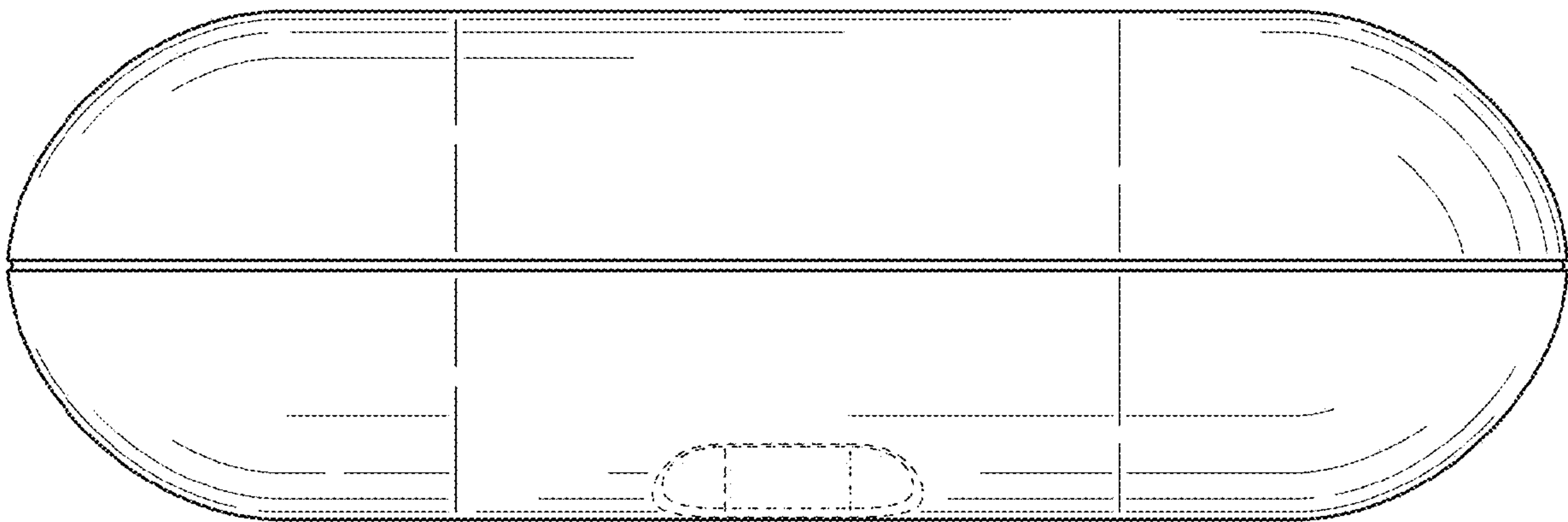


FIG. 7

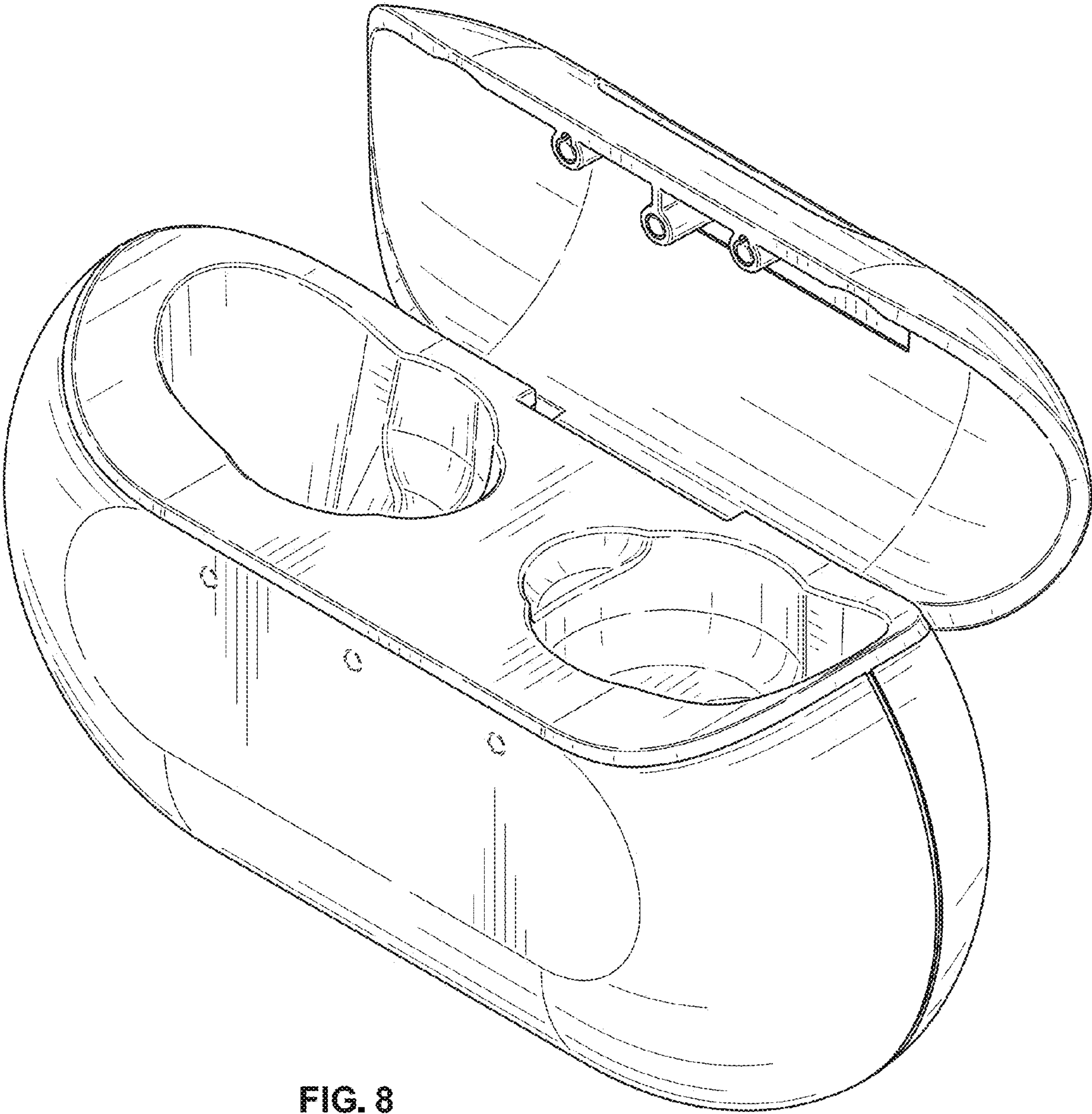


FIG. 8

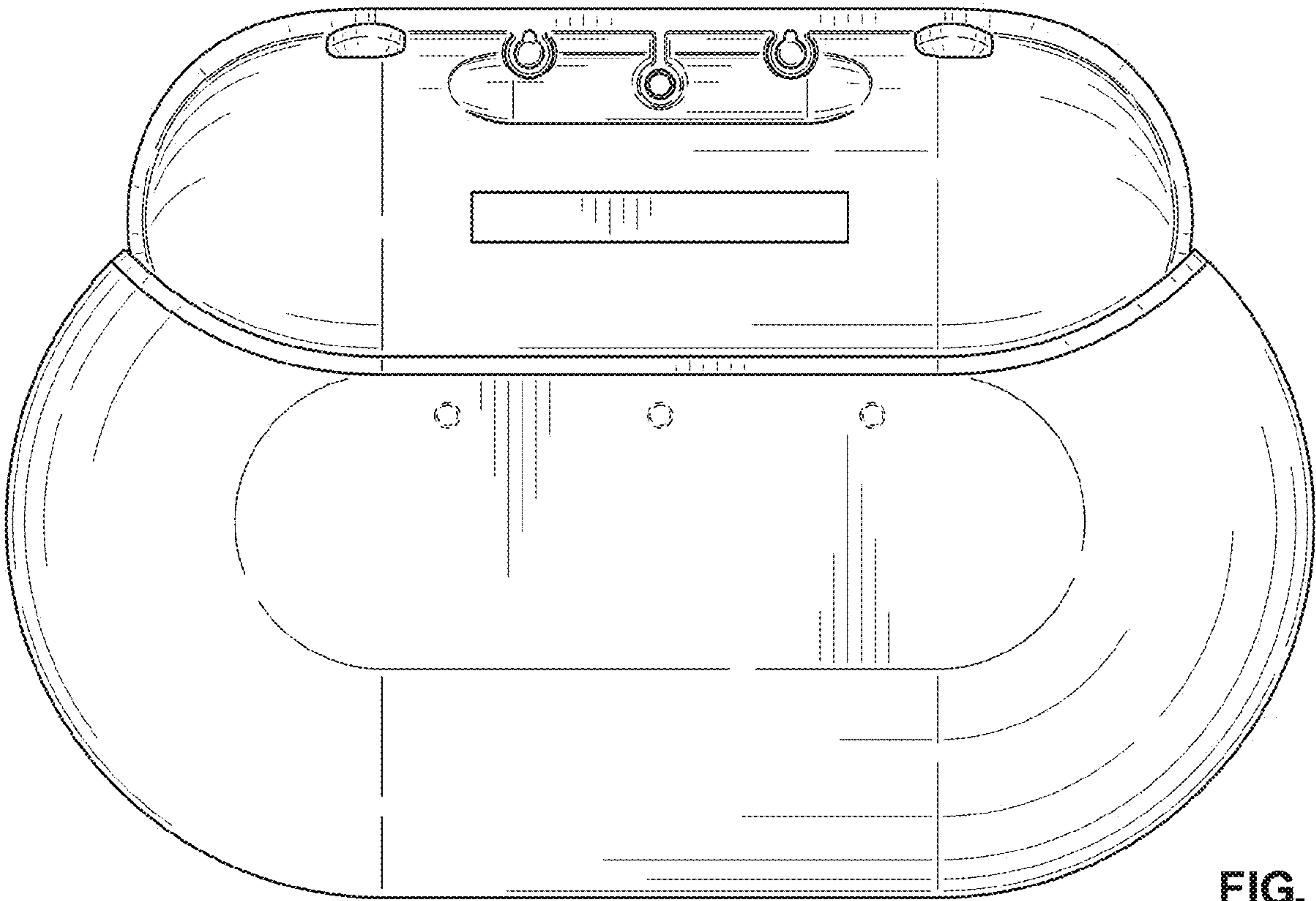


FIG. 9

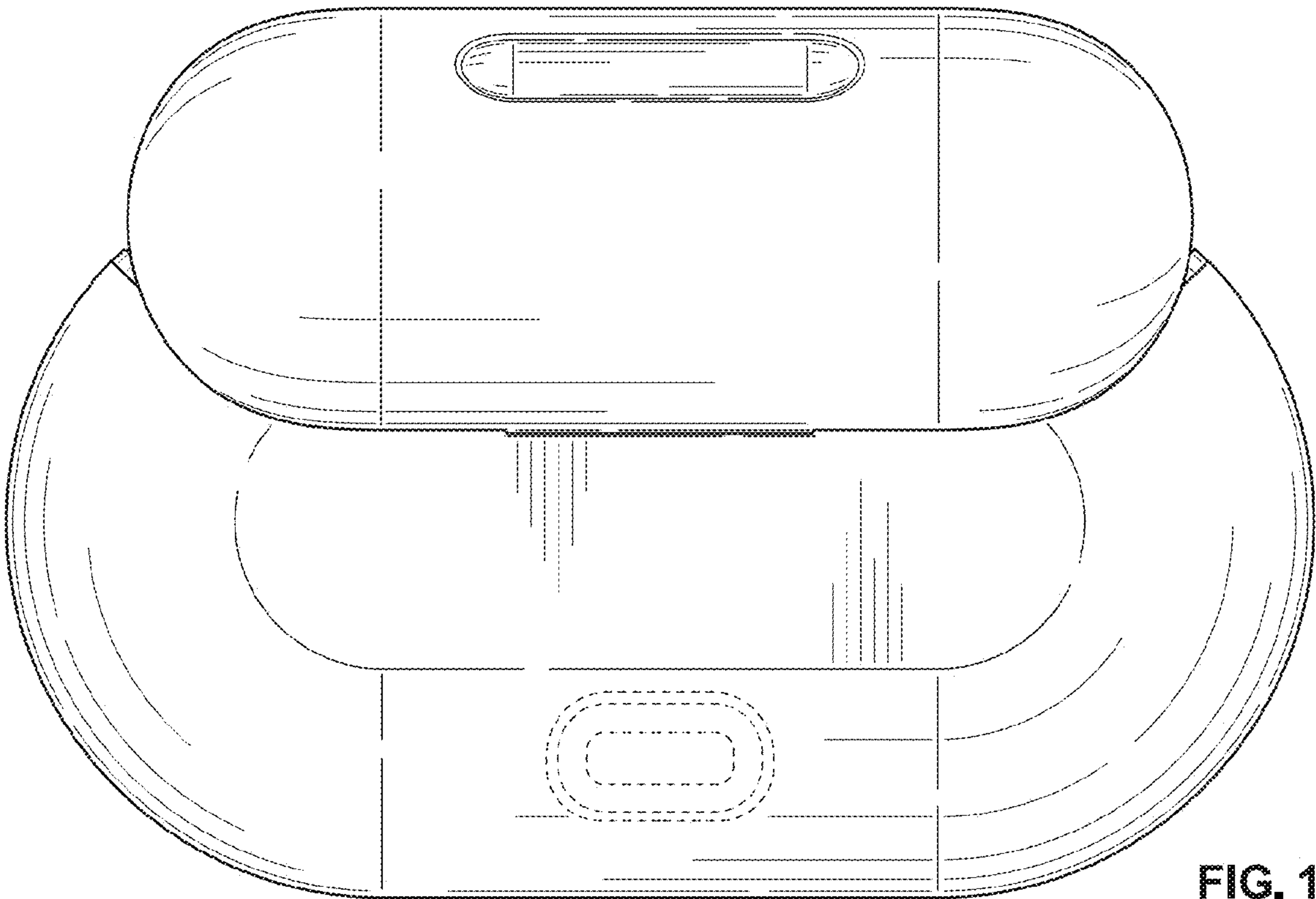


FIG. 10

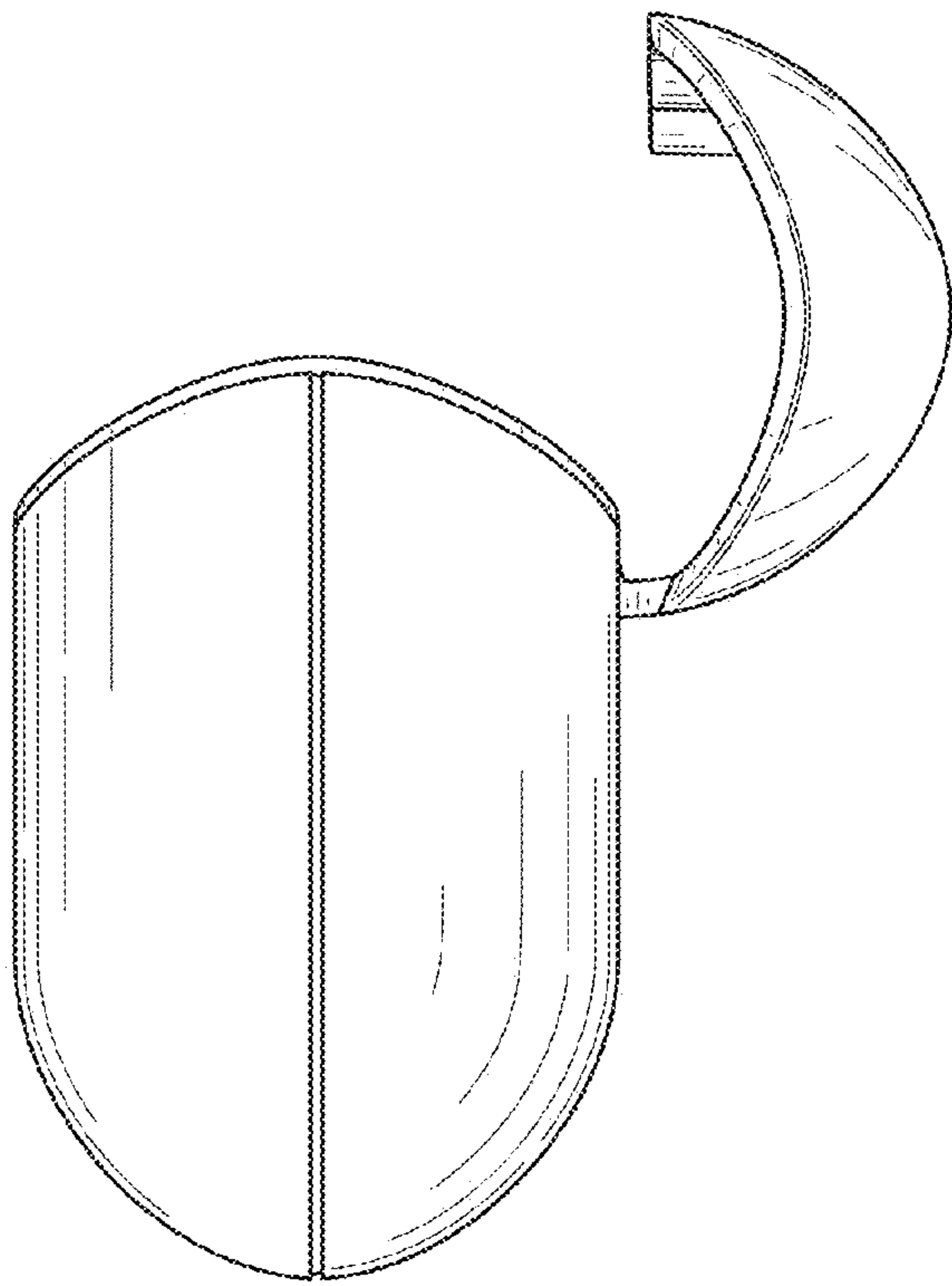


FIG. 11

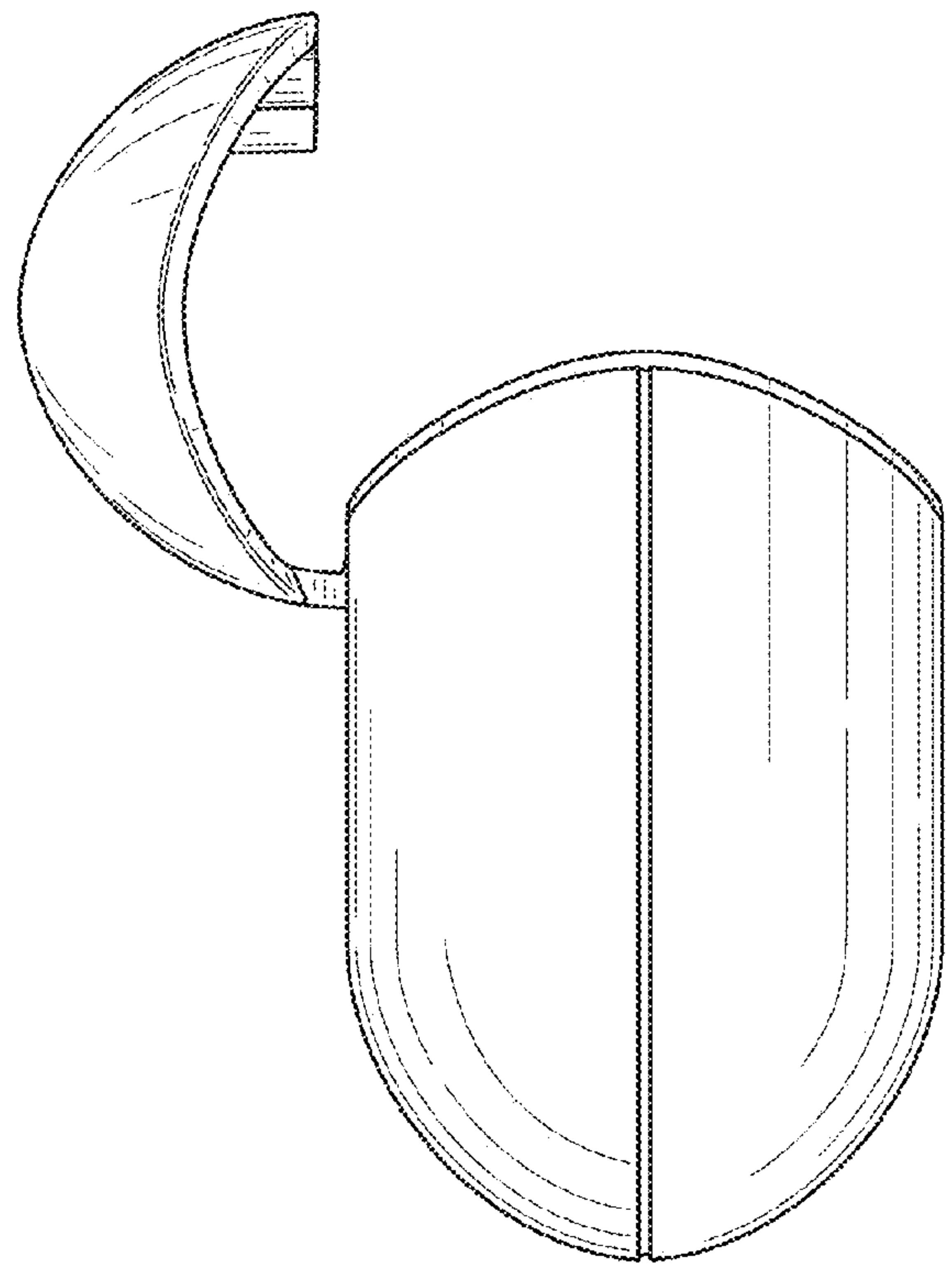


FIG. 12

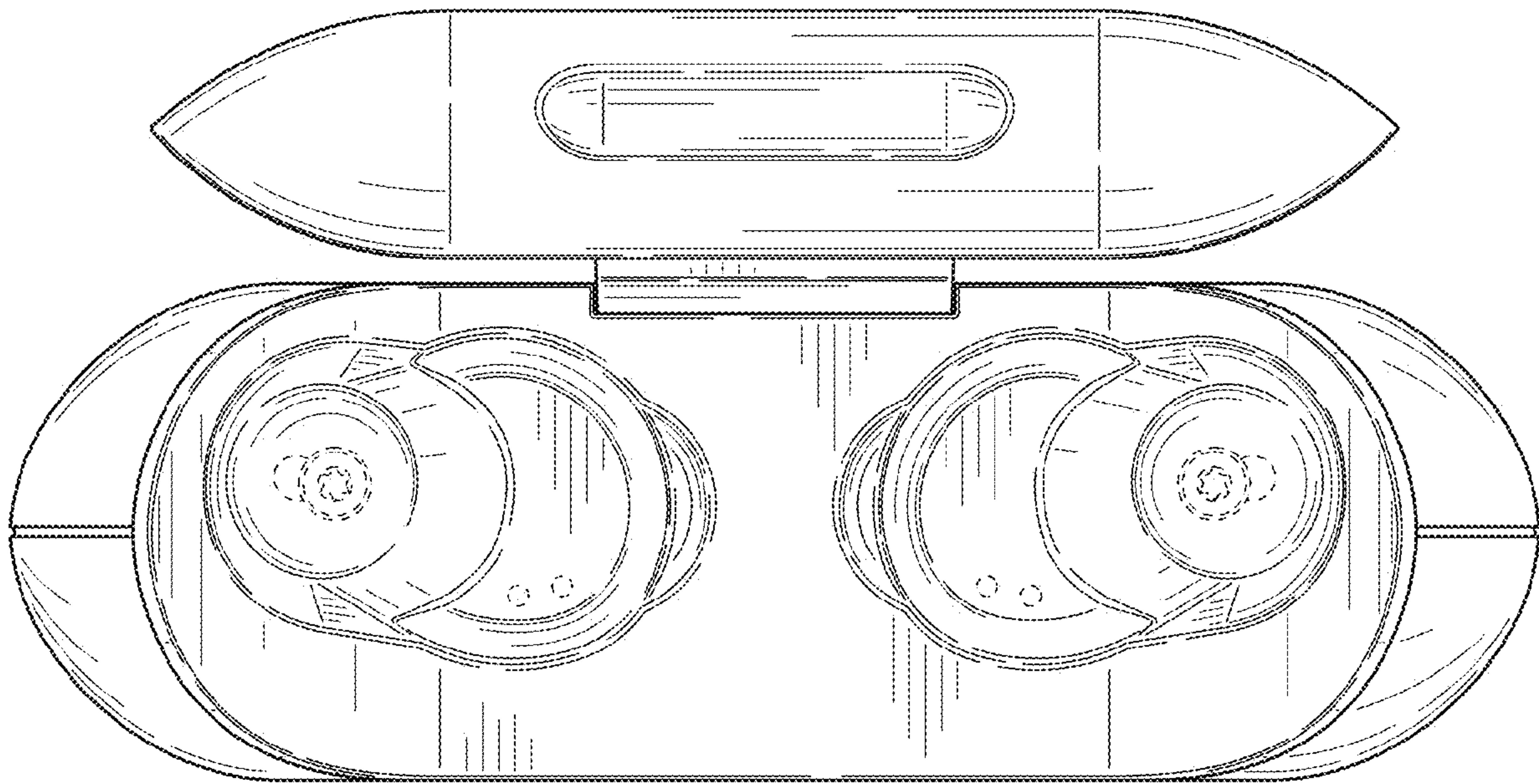


FIG. 13

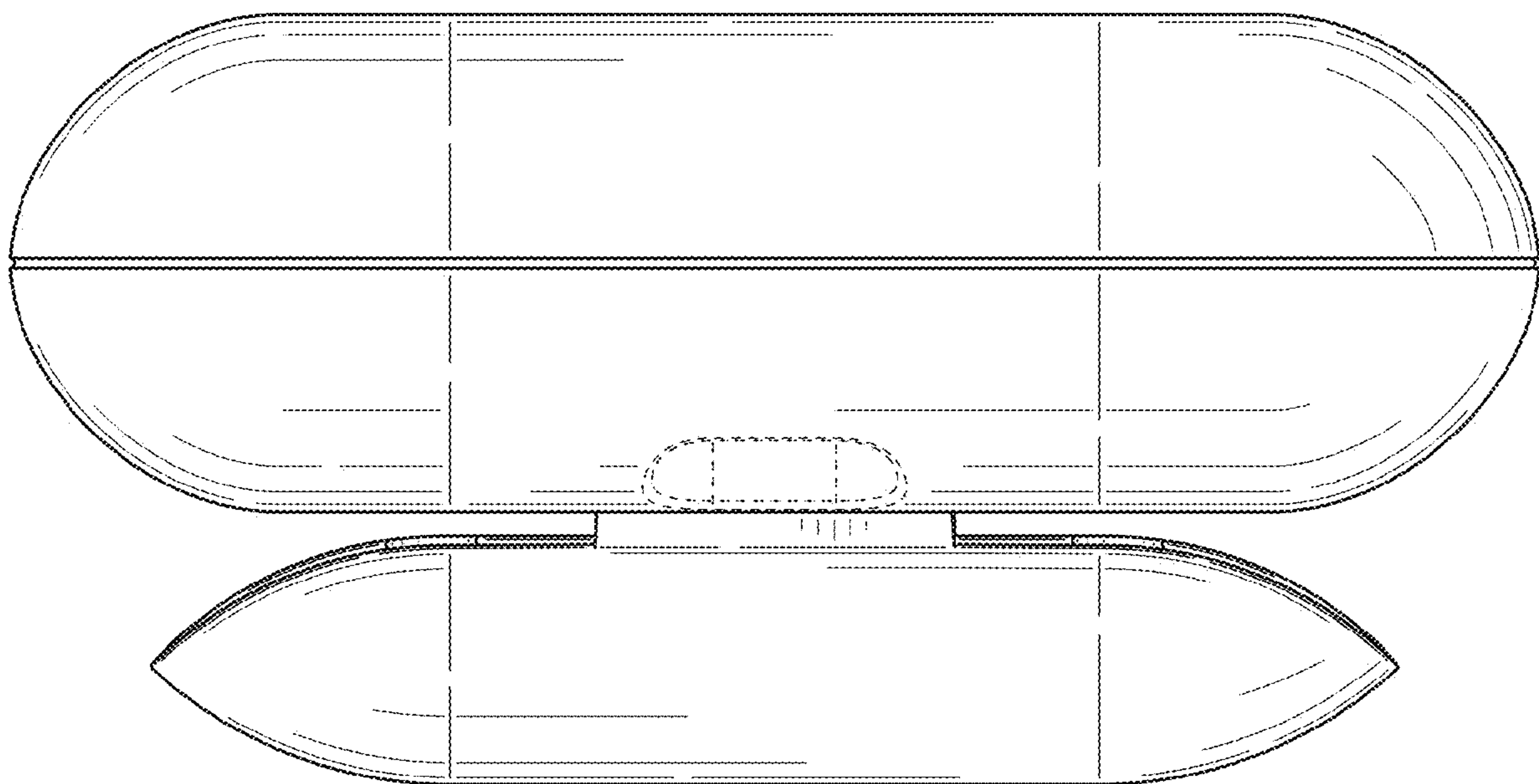


FIG. 14